

Intel Platform Memory Operations

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DDR3 1600 SoDIMM Validation Results

Listed below are the results from a small sample of DDR3 1600 SoDIMM modules tested on Intel reference mobile platforms based on Intel® 7 series/C216 chipset using 3rd Gen Intel® Core™ i7 processors (codename Ivy Bridge). DIMMs tested at 2DIMMs/channel, 2 channels loading configuration. We are providing this information as a guide to module performance with Intel® reference platforms. This testing is not intended to replace the normal OEM component qualification process. For results on specific Intel® motherboards or OEM production motherboards, please refer to the OEM's list of qualified memory suppliers.

DDR3-1600 (11-11-11) SoDIMM, 2DIMM/ch, 2 channels

DIMM Supplier	DIMM Part Number	DIMM Size	Native Voltage	Raw Card	DRAM Supplier	DRAM Part Number	DRAM Density	DRAM Width	DRAM DateCode	Tested Speed
Elpida	EBJ81UG8BBU0-GN-F	8GB	DDR3	F	Elpida	EDJ4208BBBG-GN-F	4Gb	x8	1201	1600 CL11
Elpida	EBJ40UG8BBU0-GN-F	4GB	DDR3	B	Elpida	EDJ4208BBBG-GN-F	4Gb	x8	1201	1600 CL11
Elpida	EBJ41UF8BDU0-GN-F	4GB	DDR3	F	Elpida	EDJ2108BDBG-GN-F	2Gb	x8	1203	1600 CL11
Elpida	EBJ20UF8BDU0-GN-F	2GB	DDR3	B	Elpida	EDJ2108BDBG-GN-F	2Gb	x8	1207	1600 CL11
Kingston	KVR1600D3S11/8G	8GB	DDR3	F	Elpida	EDJ4208BBBG-GN-F	4Gb	x8	1203	1600 CL11
Kingston	KVR1600D3S11/4G	4GB	DDR3	F	Elpida	EDJ2108BDBG-GN-F	2Gb	x8	1208	1600 CL11
Kingston	KVR1600D3S11/2G	2GB	DDR3	B	Elpida	EDJ2108BDBG-GN-F	2Gb	x8	1208	1600 CL11

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DIMM Supplier	DIMM Part Number	DIMM Size	Native Voltage	Raw Card	DRAM Supplier	DRAM Part Number	DRAM Density	DRAM Width	DRAM DateCode	Tested Speed
Micron	MT16KTF1G64HZ-1G6N1	8GB	DDR3	F	Micron	MT41K512M8RG-107:N	4Gb	x8	1410	1600 CL11
Micron	MT16JTF1G64HZ-1G6E1	8GB	DDR3	F	Micron	MT41K512M8RH-125:E	4Gb	x8	1226	1600 CL11
Micron	MT8KTF51264HZ-1G6N1	4GB	DDR3	B	Micron	MT41K512M8RG-107:N	4Gb	x8	1410	1600 CL11
Micron	MT8JTF51264HZ-1G6E1	4GB	DDR3	B	Micron	MT41K512M8RH-125:E	4Gb	x8	1248	1600 CL11
Micron	MT4JTF25664HZ-1G6E1	2GB	DDR3	C	Micron	MT41K256M16HA-125:E	4Gb	x8	1226	1600 CL11
Micron	MT16JTF51264HZ-1G6M1	4GB	DDR3	F	Micron	MT41K256M8DA-125:M	2Gb	x8	1151	1600 CL11
Micron	MT8JTF25664HZ-1G6M1	2GB	DDR3	B	Micron	MT41K256M8DA-125:M	2Gb	x8	1151	1600 CL11
Nanya	NT8GC64B8HB0NS-DI	8GB	DDR3	F	Nanya	NT5CB512M8BN-DI	4Gb	x8	1213	1600 CL11
Nanya	NT4GC64B88B0NS-DI	4GB	DDR3	B	Nanya	NT5CB512M8BN-DI	4Gb	x8	1213	1600 CL11
Nanya	NT2GC64BH4B0PS-DI	2GB	DDR3	C	Nanya	NT5CB256M16BP-DI	4Gb	x16	1212	1600 CL11
Nanya	NT4GC64B8HG0NS-DI	4GB	DDR3	F	Nanya	NT5CB256M8GN-DI	2Gb	x8	1134	1600 CL11
Nanya	NT2GC64B88G0NS-DI	2GB	DDR3	B	Nanya	NT5CB256M8GN-DI	2Gb	x8	1134	1600 CL11
Samsung	M471B5173DB0-CK0	4GB	DDR3	B	Samsung	K4B4G0846D-BCK0	4Gb	x8	1237	1600 CL11
Samsung	M471B1G73BH0-CK0	8GB	DDR3	F	Samsung	K4B4G0846B-HCK0	4Gb	x8	1113	1600 CL11
Samsung	M471B5273DH0-CK0	4GB	DDR3	F	Samsung	K4B2G0846D-HCK0	2Gb	x8	1140	1600 CL11

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DIMM Supplier	DIMM Part Number	DIMM Size	Native Voltage	Raw Card	DRAM Supplier	DRAM Part Number	DRAM Density	DRAM Width	DRAM DateCode	Tested Speed
Samsung	M471B5273EB0-CK0	4GB	DDR3	F	Samsung	K4B2G0846E-BCK0	2Gb	x8	1140	1600 CL11
Samsung	M471B5773DH0-CK0	2GB	DDR3	B	Samsung	K4B2G0846D-HCK0	2Gb	x8	1140	1600 CL11
Samsung	M471B5673GB0-CK0	2GB	DDR3	F	Samsung	K4B1G0846G-BCK0	1Gb	x8	1122	1600 CL11
Samsung	M471B2873GB0-CK0	1GB	DDR3	B	Samsung	K4B1G0846G-BCK0	1Gb	x8	1052	1600 CL11
SK hynix	HMT41GS6AFR8C-PB	8GB	DDR3	F	SK Hynix	H5TQ4G83AFR-PBC	4Gb	x8	1244	1600 CL11
SK hynix	HMT41GS6MFR8C-PB	8GB	DDR3	F	SK Hynix	H5TQ4G83MFR-PBC	4Gb	x8	1142	1600 CL11
SK hynix	HMT351S6EFR8C-PB	4GB	DDR3	F	SK Hynix	H5TQ2G83EFR-PBC	2Gb	x8	1218	1600 CL11
SK hynix	HMT351S6CFR8C-PB	4GB	DDR3	F	SK Hynix	H5TQ2G83CFR-PBC	2Gb	x8	1133	1600 CL11
SK hynix	HMT325S6EFR8C-PB	2GB	DDR3	B	SK Hynix	H5TQ2G83EFR-PBC	2Gb	x8	1218	1600 CL11
SK hynix	HMT325S6CFR8C-PB	2GB	DDR3	B	SK hynix	H5TQ2G83CFR-PBC	2Gb	x8	1220	1600 CL11

Created on August 14th, 2014

Approved test labs

The following test labs have the capability of performing DDR3 UDIMM system-level testing. For further information, please contact:

Advanced Validation Labs

Intel Platform Memory Operations

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